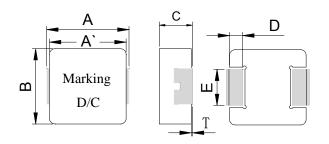
1. Part No. Expression:

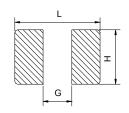
<u>PIA0603S1R0MN</u>

(a)	(b)	(C)	(d)	(e)(f)
• •	• •	• •	• •	

- a) Series Code b) Dimension Code c) Type Code d) Inductance Code
- e) Tolerance Code
- f) Internal Controlled Code

2. Configuration & Dimensions:





Recommended PC Board Pattern

Note:

1. The above PCB layout is for reference only.

Solder paste thickness of 0.15mm and above is recommended.
Marking: Top row – Inductance code, Bottom row – YYWW

Unit: mm

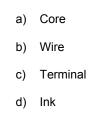
А	A`	В	С	D	E	Т	G	Н	L
7.1±0.3	6.4±0.3	6.6±0.2	2.8±0.2	1.6±0.3	3.0±0.2	0~0.15	3.7	3.4	8.0

3. Schematic:



4. Material List:





5. General Specification:

- (a) Operating Temp. : -40°C to +125°C (Inclusive of coil temp rise)
- (b) Storage Temp. : -40°C to +125°C (on board)
- (c) Humidity Range : 85 ± 2% RH
- (d) Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40°C (keep 1min)
- (e) Saturation Current (Isat Typ.) will cause L0 to drop approximately 30%.
- (f) Part Temp. (Ambient + Temp. Rise) should not exceed 125°C under worst case operating conditions.
- (g) Storage condition (component in its packaging)
 - i) Temperature: -10 to 40°C
 - ii) Humidity : 50~60% RH

6. Electrical Characteristics:

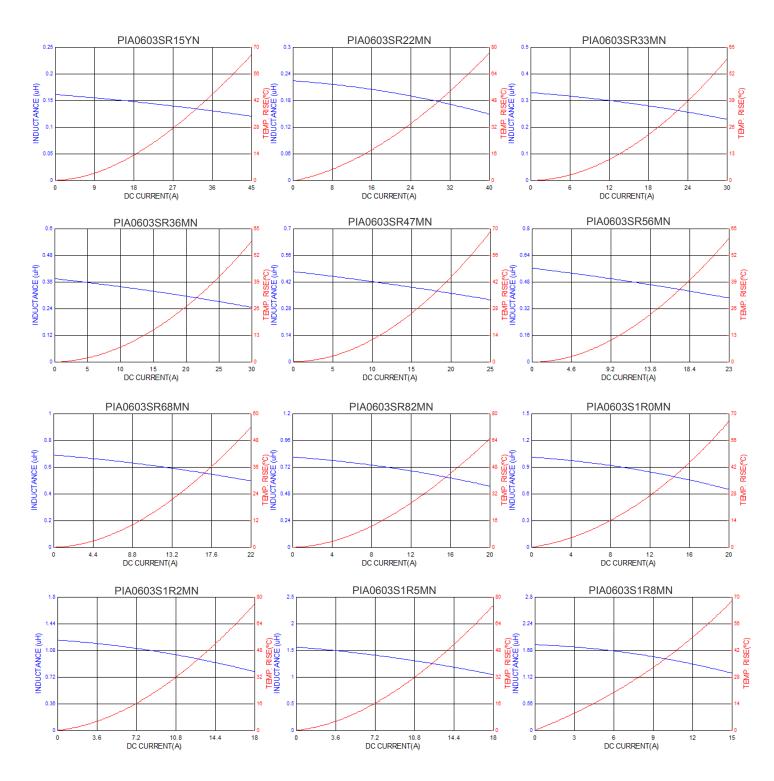
Part Number	Inductance Lo (uH)	Test Frequency, L	Heat Rating Current DC (A) Irms.		Saturation Current DC (A) Isat.		DCR (mΩ)Typ.	DCR (mΩ)Max.
	@ 0A		Тур.	Max.	Тур.	Max.	(1112) 1 9 p.	(11122)/1107X.
PIA0603SR15YN	0.15	100kHz/1.0V	30	25	40	36	1.7	2.1
PIA0603SR22MN	0.22	100kHz/1.0V	23	21	34	32	2.0	2.5
PIA0603SR33MN	0.33	100kHz/1.0V	21	20	25	22	2.8	3.4
PIA0603SR36MN	0.36	100kHz/1.0V	20	18	24	21	3.3	3.9
PIA0603SR47MN	0.47	100kHz/1.0V	18	16	20	18	3.4	4.0
PIA0603SR56MN	0.56	100kHz/1.0V	16.5	15	18	16	3.9	4.5
PIA0603SR68MN	0.68	100kHz/1.0V	16	14.5	17	15	4.7	5.3
PIA0603SR82MN	0.82	100kHz/1.0V	14	13	16	14	5.4	6.0
PIA0603S1R0MN	1.00	100kHz/1.0V	12	11	15	13.5	6.7	7.4
PIA0603S1R2MN	1.20	100kHz/1.0V	10	9.5	14	12.5	7.7	9.5
PIA0603S1R5MN	1.50	100kHz/1.0V	10	9.0	14	12	10.2	12.1
PIA0603S1R8MN	1.80	100kHz/1.0V	9.0	8.0	12	10	10.9	13
PIA0603S2R2MN	2.20	100kHz/1.0V	8.0	7.5	10	9.0	13.5	15
PIA0603S2R7MN	2.70	100kHz/1.0V	7.2	7.0	9.8	8.8	17.3	20
PIA0603S3R3MN	3.30	100kHz/1.0V	6.5	6.0	9.5	8.5	19	22
PIA0603S4R7MN	4.70	100kHz/1.0V	5.5	5.0	6.5	5.5	28	33
PIA0603S5R6MN	5.60	100kHz/1.0V	5.5	5.0	6.0	5.2	39	42
PIA0603S6R8MN	6.80	100kHz/1.0V	4.5	4.2	6.0	5.0	43	50
PIA0603S8R2MN	8.20	100kHz/1.0V	4.5	4.0	6.0	4.7	54	60
PIA0603S100MN	10.0	100kHz/1.0V	4.0	3.5	5.5	4.5	62	68
PIA0603S150MN	15.0	100kHz/1.0V	3.0	2.5	4.5	4.0	110	140
PIA0603S220MN	22.0	100kHz/1.0V	2.5	2.0	3.0	2.5	150	190
PIA0603S330MN	33.0	100kHz/1.0V	2.1	1.8	2.5	2.0	215	258

*Tolerance code : M = $\pm 20\%$, Y= $\pm 30\%$

Notes:

1) At all times, the current supplied to the product should not exceed Isat Max. value.

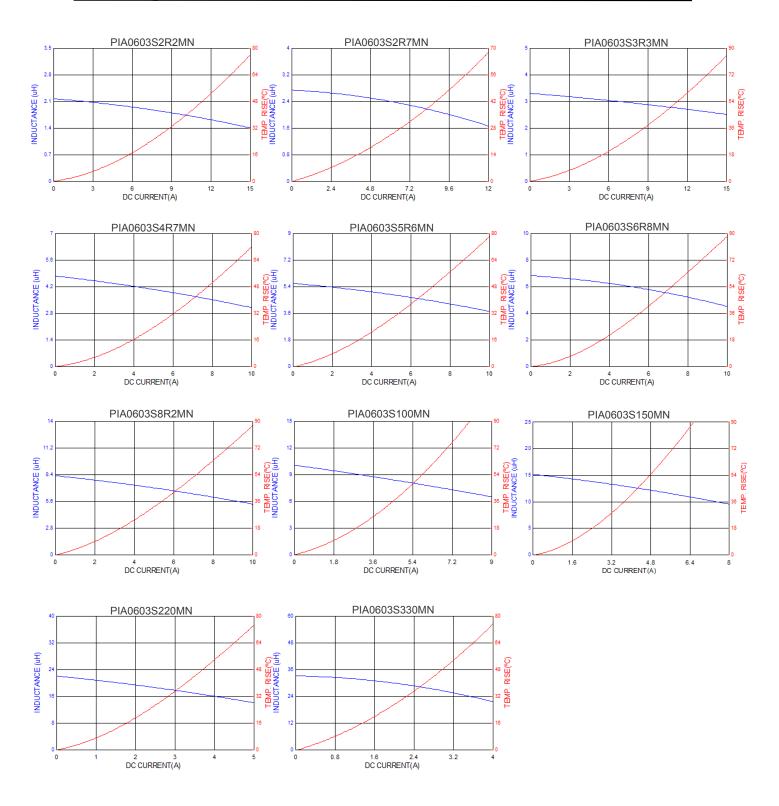
7. Characteristics Curves:



NOTE: Specifications subject to change without notice. Please check our website for latest information.

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SMD High Current Molded Inductor – PIA0603S Series



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8. Soldering:

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air.

8-1.1 Solder Re-flow:

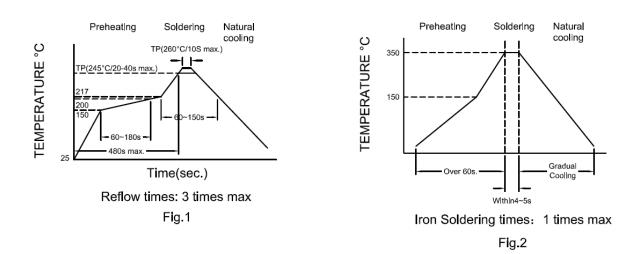
Recommended temperature profiles for re-flow soldering in Figure 1.

8-1.2 Soldering Iron (Figure 2):

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

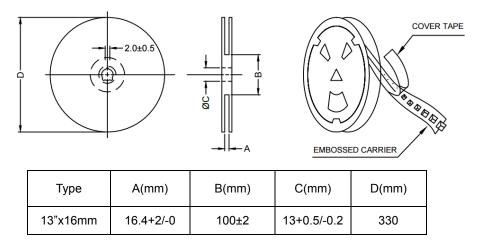
Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 secs.

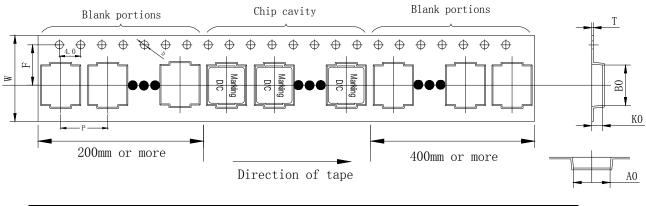


9. Packaging Information:

9-1 Reel Dimension



9-2 Tape Dimension



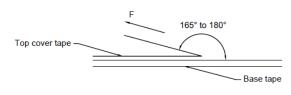
Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	T(mm)	D(mm)
PIA	0603	7.7±0.1	7.0±0.1	3.3±0.1	12.0±0.1	16±0.3	7.5±0.1	0.35±0.05	1.5±0.1

9-3 Packaging Quantity

PIA	0603
Chip / Reel	1000
Inner box	2000
Carton	8000

SMD High Current Molded Inductor – PIA0603S Series

9-4 Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions.

Room Temp. (℃)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

Application Notice:

1. Storage Conditions:

To maintain the solderabililty of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.